

## Electronic Patent Application Fee Transmittal

Application Number:	10823221			
Filing Date:	13-Apr-2004			
Title of Invention:	Integrated circuit devices having pad contact plugs in the cell array and peripheral circuit regions of the integrated circuit substrate and methods of forming the same			
First Named Inventor/Applicant Name:	Se-Hoon Oh			
Filer:	Elizabeth A. Stanek/Erin Dutton			
Attorney Docket Number:	5649-1228			
Filed as Large Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Request for continued examination	1801	1	790	790
<b>Total in USD (\$)</b>				<b>790</b>